



Docket No.: 060188-0747

PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re REISSUE Application of : Customer Number: 20277  
Yukio YAMAGUCHI : Confirmation Number: 2437  
Application No.: 10/761,098 : Group Art Unit: 2812  
Filed: January 21, 2004 : Examiner: GEYER, Scott B.

For: LEAD FRAME, RESIN-MOLDED SEMICONDUCTOR DEVICE, AND METHOD FOR  
MANUFACTURING THE SAME

**PETITION FOR EXTENSION OF TIME**

Mail Stop Amendment  
Honorable Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

It is respectfully requested that the time for response to the Office Action dated  
March 15, 2006, now due to expire June 15, 2006, be extended for two month(s) and set to  
expire on August 15, 2006.

Please charge the extension fee of \$450.00 to Deposit Account No. 500417. Please  
charge any additional fees or credit any overpayment to Deposit Account No. 500417.

Respectfully submitted,

08/16/2006 FMEYK11 00000006 500417 10761098

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McDERMOTT WILL & EMERY LLP

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Facsimile: 202.756.8087  
**Date: August 15, 2006**

**Please recognize our Customer No. 20277  
as our correspondence address.**